

## PATENT ASSIGNMENT COVER SHEET

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 Stylesheet Version v1.2

EPAS ID: PAT6237472

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT	
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT	
<b>CONVEYING PARTY DATA</b>		
	<b>Name</b>	<b>Execution Date</b>
	DAVID WEISS	02/19/2018
<b>RECEIVING PARTY DATA</b>		
<b>Name:</b>	ECK INDUSTRIES INCORPORATED	
<b>Street Address:</b>	1602 N. 8TH ST.	
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<b>State/Country:</b>	WISCONSIN	
<b>Postal Code:</b>	54220	
<b>PROPERTY NUMBERS Total: 1</b>		
<b>Property Type</b>	<b>Number</b>	
<b>Application Number:</b>	16924940	
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<b>SIGNATURE:</b>	/Johanna P. Schwartz/	
<b>DATE SIGNED:</b>	08/06/2020	
<b>Total Attachments: 3</b>		
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## ASSIGNMENT

**Assignor:**

David Weiss, a U.S. citizen, residing at 1361 Hazelwood Dr.  
Manitowoc, WI 54220

**Assignee:**

**Eck Industries Incorporated**, a Wisconsin corporation, having a place of business at  
1602 N. 8th Street, Manitowoc, Wisconsin 54220, USA

Pursuant to Assignor's obligation to Assignee(s), and for other valuable and sufficient consideration, the receipt whereof is hereby acknowledged, Assignor hereby sells, assigns and conveys:

to **Eck Industries Incorporated** and its successors and assigns, the entire right, title, and interest in and to:

(a) the patent applications listed in Schedule A attached hereto, including without limitation, the worldwide rights to the inventions described and claimed therein, including any provisionals, non-provisionals, reissues, reexaminations, divisionals, continuations, continuations-in-part, renewals, extensions, and international patent applications therefor throughout the world, together with all rights under the International Convention for the Protection of Industrial Property and any similar treaties or agreements, and in and to the patent or patents to be granted thereon, to the full end of the term or terms for which said patent or patents may be granted (collectively "Patent Applications");

(b) any and all royalties, fees, income, payments and other proceeds now or hereafter due or payable with respect to any of the Patent Applications; and

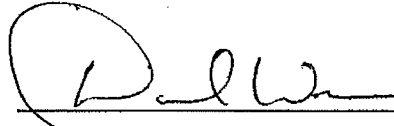
(c) any and all claims and causes-of-action with respect to any of the Patent Applications, whether accruing before, on or after the date hereof, including all rights to and claims for damages, restitution and injunctive and other legal and equitable relief for past, present and future infringement, misappropriation, violation, misuse, breach or default, with the right but no obligation to sue for such legal and equitable relief and to collect, or otherwise recover, any such damages.

Assignor hereby agrees that Assignor will, upon demand of Assignee, its successors or assigns, and without further consideration to Assignor, execute any and all papers that may be

necessary, or deemed by Assignee, its successors or assigns, to be necessary, for a complete fulfillment of the intent and purposes of this Assignment, it being understood that any expense incident to the execution of such papers shall be paid by Assignee, its successors and assigns, and not by Assignor.

The Commissioner of Patents and Trademarks of the United States is hereby authorized and requested to issue said patent or patents to Assignee(s).

2/19/18  
Date

  
David Weiss

**SCHEDULE A**

Application No.	Filing Date	Inventor(s)	Title
15/650,664	July 14, 2017	Alex J. Plotkowski; Orlando Rios; Sudarsanam Suresh Babu; Ryan R. Dehoff; Ryan Ott; Zachary C. Sims; Niyanth Sridharan; David Weiss; and Hunter B. Henderson	ADDITIVE MANUFACTURING METHODS USING ALUMINUM-RARE EARTH ALLOYS AND PRODUCTS MADE USING SUCH METHODS
15/650,743	July 14, 2017	Alex J. Plotkowski, Orlando Rios, Sudarsanam Suresh Babu, Ryan R. Dehoff, Ryan Ott, Zachary C. Sims, Niyanth Sridharan, David Weiss, and Hunter B. Henderson	SURFACE-HARDENED ALUMINUM-RARE EARTH ALLOYS AND METHODS OF MAKING THE SAME